



HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- n HIGH VOLTAGE CAPABILITY
- n LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- n VERY HIGH SWITCHING SPEED

APPLICATION

- n COMPACT FLUORESCENT LAMPS (CFLS)
- SWITCH MODE POWER SUPPLIES (AC / DC CONVERTERS)



The device is manufactured using high voltage Multi-Epitaxial Planar technology for high switching speeds and high voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

Figure 1: Package

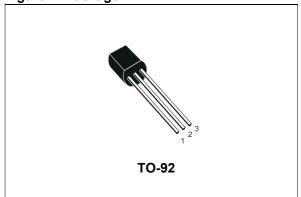


Figure 2: Internal Schematic Diagram

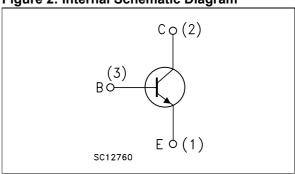


Table 1: Order Code

| Part Number | Marking | Package | Packaging | |
|-------------|---------|----------|-----------|--|
| STX13005 | X13005 | TO-92 | Bulk | |
| STX13005-AP | X13005 | TO-92 AP | Ammopack | |

Table 2: Absolute Maximum Ratings

| Symbol | Parameter | Value | Unit |
|------------------|--|----------------------|------|
| V _{CES} | Collector-Emitter Voltage (V _{BE} = 0) | 700 | V |
| V_{CEO} | Collector-Emitter Voltage (I _B = 0) | 400 | V |
| V_{EBO} | Emitter-Base Voltage (I_C = 0, I_B = 1.5 A, t_p < 10ms) | V _{(BR)EBO} | V |
| I _C | Collector Current | 3 | Α |
| I _{CM} | Collector Peak Current (t _p < 5ms) | 6 | Α |
| Ι _Β | Base Current | 1.5 | Α |
| I _{BM} | Base Peak Current (t _p < 5ms) | 3 | Α |
| P _{tot} | Total Dissipation at T _C = 25 °C | 2.8 | W |

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| Symbol | Parameter | Value | Unit |
|------------------|-------------------------------------|------------|------|
| T _{stg} | Storage Temperature | -65 to 150 | °C |
| T _J | Max. Operating Junction Temperature | 150 | °C |

Table 3: Thermal Data

| Symbol | Parameter | | | Unit |
|-----------------------|-------------------------------------|-----|------|------|
| R _{thj-case} | Thermal Resistance Junction-Case | Max | 44.6 | °C/W |
| R _{thj-amb} | Thermal Resistance Junction-ambient | Max | 150 | °C/W |

Table 4: Electrical Characteristics (T_{case} = 25 °C unless otherwise specified)

| Symbol | Parameter | Test Cor | nditions | Min. | Тур. | Max. | Unit |
|------------------------|---------------------------|--|----------------------------|------|------|------|------|
| I _{CES} | Collector Cut-off Current | V _{CE} = 700 V | | | | 1 | mA |
| | (V _{BE} = 0) | V _{CE} = 700 V | T _j = 125 °C | | | 5 | mA |
| I _{CEO} | Collector Cut-off Current | V _{CE} = 400 V | | | | 1 | mA |
| | $(I_B = 0)$ | | | | | | |
| V _{(BR)EBO} | Emitter-Base | I _E = 10 mA | L = 25 mH | 9 | | 18 | V |
| | Breakdown Voltage | | | | | | |
| | $(I_C = 0)$ | | | | | | |
| V _{CE(sus)} * | Collector-Emitter | I _C = 10 mA | | 400 | | | V |
| | Sustaining Voltage | | | | | | |
| | $(I_B = 0)$ | | | | | | |
| V _{CE(sat)} * | Collector-Emitter | I _C = 1 A | I _B = 200 mA | | | 0.5 | V |
| | Saturation Voltage | I _C = 2 A | $I_B = 500 \text{ mA}$ | | | 0.6 | V |
| | | I _C = 3 A | I _B = 750 mA | | | 5 | V |
| V _{BE(sat)} * | Base-Emitter | I _C = 1 A | I _B = 200 mA | | | 1.2 | V |
| | Saturation Voltage | I _C = 2 A | I _B = 500 mA | | | 1.6 | V |
| h _{FE} * | DC Current Gain | I _C = 1 A | V _{CE} = 5 V | 10 | | 30 | |
| | | I _C = 2 A | $V_{CE} = 5 V$ | 8 | | 24 | |
| | RESISTIVE LOAD | I _C = 2 A | V _{CC} = 125 V | | | | |
| t_s | Storage Time | I _{B1} = - I _{B2} = 400 mA | t _p = 30 μs | | 1.65 | | μs |
| t _f | Fall Time | (see figure 16) | , | | 260 | | ns |
| | INDUCTIVE LOAD | I _C = 1 A | V _{Clamp} = 300 V | | | | |
| t_s | Storage Time | I _{B1} = 200 mA | $V_{BE(off)} = -5 V$ | | 8.0 | | μs |
| t _f | Fall Time | L = 50 mH | $R_{BB} = 0$ | | 150 | | ns |
| | | (see figure 15) | | | | | |

^{*} Pulsed: Pulsed duration = 300 μ s, duty cycle \leq 1.5 %.

Figure 3: Safe Operating Area

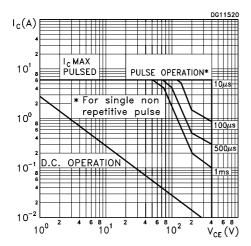


Figure 4: Output Chatacterisctics

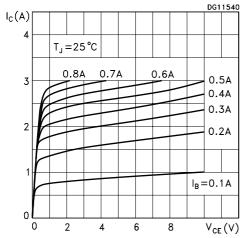


Figure 5: DC Current Gain

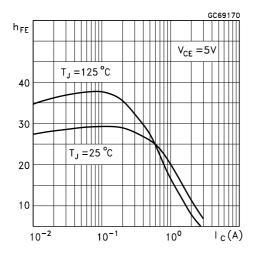


Figure 6: Derating Curve

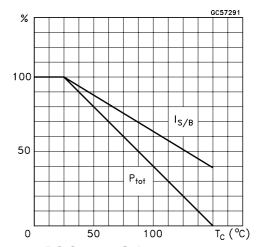


Figure 7: DC Current Gain

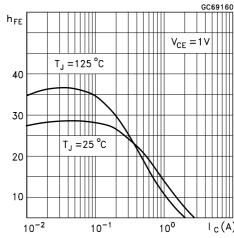


Figure 8: Collector-Emitter Saturation Voltage

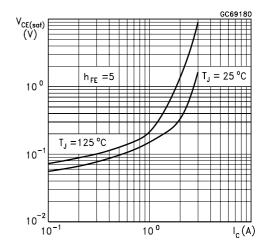


Figure 9: Base-Emitter Saturation Voltage

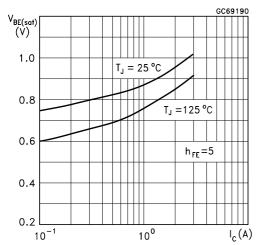


Figure 10: Resistive Load Fall Time

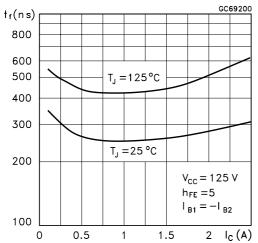


Figure 11: Inductive Load Fall Time

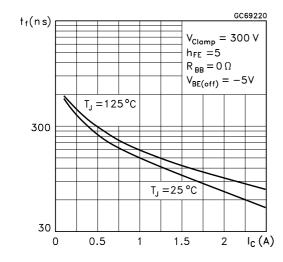


Figure 12: Resistive Load Storage Time

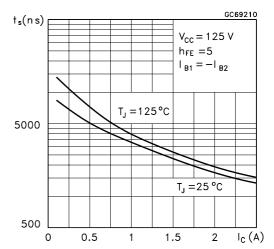


Figure 13: Inductive Load Storage Time

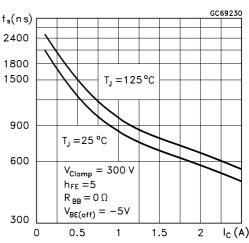


Figure 14: Reverse Biased Safe Operating Area

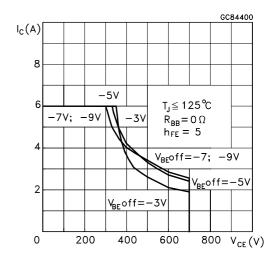


Figure 15: Inductive Load Switching Test Circuit

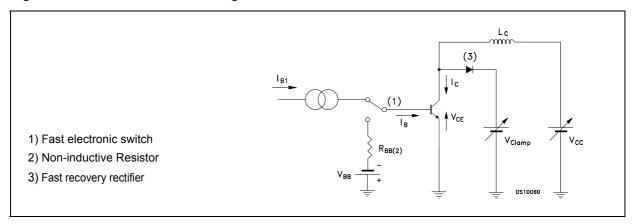
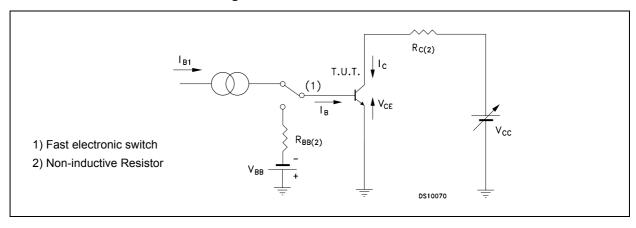
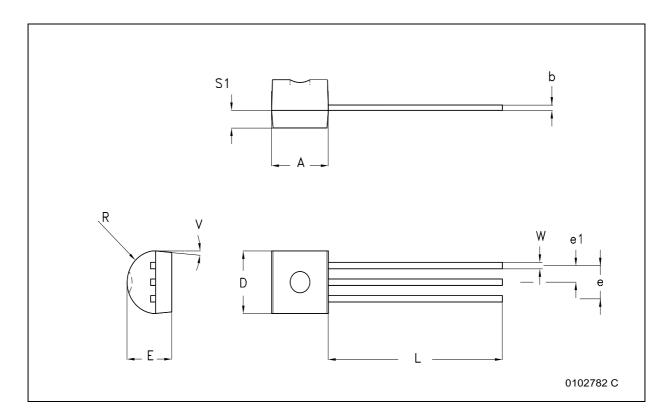


Table 16: Restistive Load Switching Test Circuit



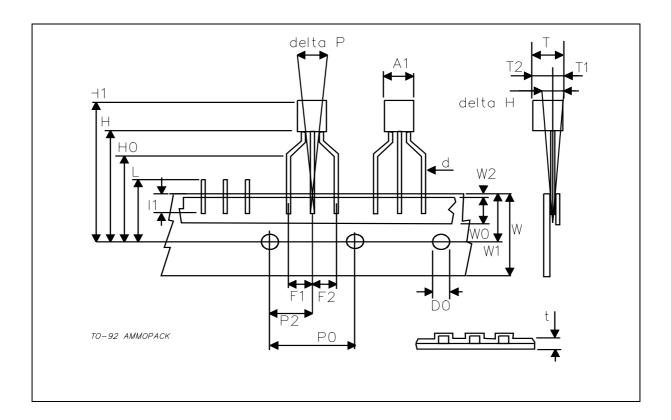
TO-92 BULK SHIPMENT MECHANICAL DATA

| DIM. | mm. | | | | | |
|------|-------|----------------|-------|--|--|--|
| | MIN. | TYP | MAX. | | | |
| А | 4.32 | | 4.95 | | | |
| b | 0.36 | | 0.51 | | | |
| D | 4.45 | | 4.95 | | | |
| E | 3.30 | | 3.94 | | | |
| е | 2.41 | | 2.67 | | | |
| e1 | 1.14 | | 1.40 | | | |
| L | 12.70 | | 15.49 | | | |
| R | 2.16 | | 2.41 | | | |
| S1 | 0.92 | | 1.52 | | | |
| W | 0.41 | | 0.56 | | | |
| V | | 5 ^O | | | | |



TO-92 AMMOPACK SHIPMENT (Suffix"-AP") MECHANICAL DATA

| DIM. | mm. | | | |
|---------|-------|-------|-------|--|
| | MIN. | TYP | MAX. | |
| A1 | | | 4.80 | |
| Т | | | 3.80 | |
| T1 | | | 1.60 | |
| T2 | | | 2.30 | |
| d | | | 0.48 | |
| P0 | 12.50 | 12.70 | 12.90 | |
| P2 | 5.65 | 6.35 | 7.05 | |
| F1,F2 | 2.44 | 2.54 | 2.94 | |
| delta H | -2.00 | | 2.00 | |
| W | 17.50 | 18.00 | 19.00 | |
| W0 | 5.70 | 6.00 | 6.30 | |
| W1 | 8.50 | 9.00 | 9.25 | |
| W2 | | | 0.50 | |
| Н | 18.50 | | 20.50 | |
| H0 | 15.50 | 16.00 | 16.50 | |
| H1 | | | 25.00 | |
| D0 | 3.80 | 4.00 | 4.20 | |
| t | | | 0.90 | |
| L | | | 11.00 | |
| I1 | 3.00 | | | |
| delta P | -1.00 | | 1.00 | |



STX13005

Table 5: Revision History

| Date | Release | Change Designator |
|-------------|---------|----------------------|
| 01-Jul-2004 | 1 | First Release. |
| 11-Feb-2005 | 2 | New table on page 1. |

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